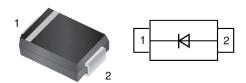
CREATEK Microelectronics

# Super Fast Surface Mount Rectifier in DO-214AA/SMB

#### **Features**

- For surface mounted application
- Glass passivated junction chip
- Built-in strain relief
- ideal for automated placement
- Superfast recovery time for high efficiency



12.0

-55 to +150

-55 to +150

#### **Mechanical Data**

■ Case: JEDEC DO-214AA(SMB)molded plastic Lead free; RoHS compliant; Halogen free

■ Molding Compound Flammability Rating:

UL 94 V-0

■ **Terminals:** High temperature soldering guaranteed:

**Maximum Ratings And Electrical Characteristics** 

260 °C/10 sec. at terminals

Single phase half-wave 60Hz, resistive or inductive load, for cap	acilive load	current c	lerate by	20%.					
Parameter	Symbols	ES3AB	ES3BB	ES3DB	ES3GB	ES3JB	ES3KB	ES3MB	Units
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified current See Fig. 1 @ T <sub>L</sub> =90°C	I <sub>(AV)</sub>				3.0				Amp
Peak forward surge current, 8.3 ms single half sine- wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>				100.0				Amps
Maximum instantaneous forward voltage @ 1.0A	$V_{F}$	0.95 1.25 1.7			Volts				
Maximum DC reverse current $@T_A=25^{\circ}C$ at rated DC blocking voltage $@T_A=125^{\circ}C$	I <sub>R</sub>				10.0 500	•			uА
Maximum reverse recovery time (Note 1)	t <sub>rr</sub>				35				nS
Typical junction capacitance (Note 2)	C,	50			pF				
Typical thermal resistance (Note 3)	R <sub>eJA</sub>	47.0 12.0			°C/W				

1. Reverse Recovery Test Conditions: I<sub>E</sub>=0.5A, I<sub>R</sub>=1.0A, I<sub>RR</sub>=0.25A

2. Measured at 1 MHz and Applied V\_=4.0 Volts

Operating temperature range

Storage temperature range

3. Thermal Resistance from Junction to Ambient and from Junction to Lead Mounted on P.C.B. with 0.2" x 0.2" (5.0 x 5.0 mm) Copper Pad Areas

 $T_J$ 

 $\mathsf{T}_{\mathsf{STG}}$ 

°С

٥С



# **ES3AB thur ES3MB**

### **CREATEK Microelectronics**

## $\textbf{Typical Characteristics} \,\, (\textbf{T}_{amb} = 25 \,\, ^{\circ}\text{C unless otherwise specified})$

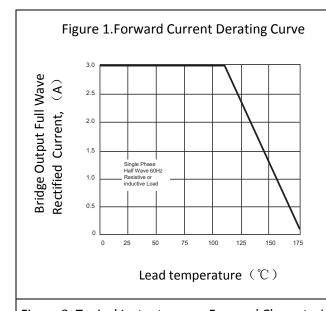
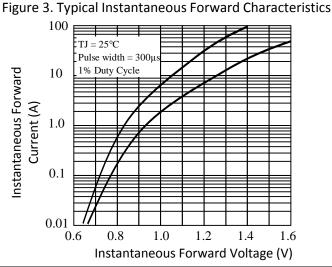
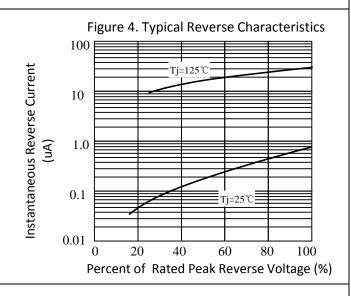
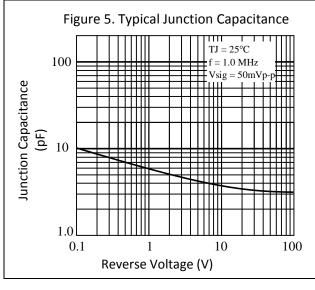


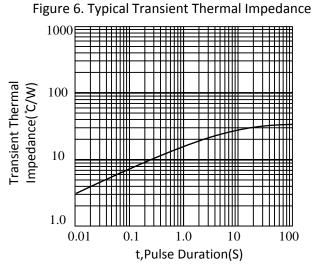
Figure 2.Maximum Non-Repetitive Peak Forward Surge Current

125
100
75
100
100
100
Number of Cycles at 60Hz





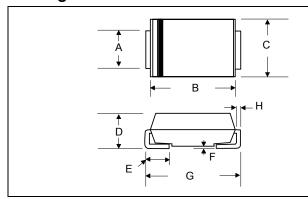






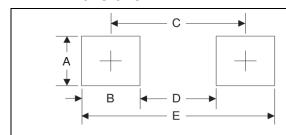
## **CREATEK Microelectronics**

# **Package Dimensions**



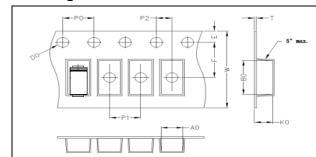
O. mahad	Dimensions in millimeters		
Symbol	Min	Max	
Α	1.80	2.20	
В	4.06	4.57	
С	3.30	3.94	
D	1.99	2.61	
E	0.90	1.41	
F	0.10	0.20	
G	5.08	5.59	
Н	0.15	0.31	

### **PAD Dimensions**



Symbol	Unit (mm)	Unit (inch)
Α	2.30	0.091
В	2.00	0.078
С	4.10	0.161
D	2.10	0.083
Е	6.10	0.240

## **Packing Information**



Α0	В0	K0	D0	E	F
3.80	5.40	2.45	1.55	1.75	5.50
P0	P1	P2	Т	w	Tolerance
4.0	8.0	2.0	0.25	12	0.1

# Marking





## **Ordering information**

Order code	Package	Packaging option	Base quantity	Packaging specification
ES3AB thur ES3MB	DO-214AA/SMB	Tape and reel	3000pcs / reel	EIA STD RS-481

## **Revision history**

Date	Revision	Changes
23-May-2016	1.0	Initial release



# **ES3AB thur ES3MB**

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